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FULL ESTIMATED COST

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- => s (silica or glass) and powder and sedimentation
 L1 11555 (SILICA OR GLASS) AND POWDER AND SEDIMENTATION
- => s ((silica or glass)(w)powder) and sedimentation L2 628 ((SILICA OR GLASS)(W) POWDER) AND SEDIMENTATION

=> dup rem L2
PROCESSING IS APPROXIMATELY 67% COMPLETE FOR L2
PROCESSING IS APPROXIMATELY 76% COMPLETE FOR L2
PROCESSING IS APPROXIMATELY 85% COMPLETE FOR L2
PROCESSING COMPLETED FOR L2

L3 628 DUP REM L2 (0 DUPLICATES REMOVED)

=> s L3 not py>1986 L4 50 L3 NOT PY>1986

=> d L4 1-25 ti

- L4 ANSWER 1 OF 50 USPATFULL on STN
- TI Filler for electronic element encapsulation resin and electronic element encapsulation resin composition containing the same
- L4 ANSWER 2 OF 50 USPATFULL on STN
- TI Heat exchange element
- L4 ANSWER 3 OF 50 USPATFULL on STN
- TI Shaped article and composite material and method for producing same
- L4 ANSWER 4 OF 50 USPATFULL on STN
- TI Abrasive, production thereof and use thereof in magnetic recording medium
- L4 ANSWER 5 OF 50 USPATFULL on STN
- TI Method for impregnating and embedding electrical windings

- L4 ANSWER 6 OF 50 USPATFULL on STN
- TI Cellular glass coated with a heat insulator
- L4 ANSWER 7 OF 50 USPATFULL on STN
- TI Deep dielectric isolation by fused glass
- L4 ANSWER 8 OF 50 USPATFULL on STN
- TI Glass composition for covering semiconductor element
- L4 ANSWER 9 OF 50 USPATFULL on STN
- TI Process for hydrocracking hydrocarbons with hydrotreatment-regeneration of spent catalyst
- L4 ANSWER 10 OF 50 USPATFULL on STN
- TI Method for forming recessed isolated regions
- L4 ANSWER 11 OF 50 USPATFULL on STN
- TI Method for forming a planarized integrated circuit
- L4 ANSWER 12 OF 50 USPATFULL on STN
- TI Method and apparatus for separating lymphocytes from anticoagulated blood
- L4 ANSWER 13 OF 50 USPATFULL on STN
- TI Enameled wires having resistance to overload and process for producing the same
- L4 ANSWER 14 OF 50 USPATFULL on STN
- TI Method of manufacturing cement products having superior mechanical strength
- L4 ANSWER 15 OF 50 USPATFULL on STN
- TI Production of porous gels and ceramic materials
- L4 ANSWER 16 OF 50 USPATFULL on STN
- TI Flowable herbicides
- L4 ANSWER 17 OF 50 USPATFULL on STN
- TI Acicular aluminium salts of carboxylic acids and processes for their preparation
- L4 ANSWER 18 OF 50 USPATFULL on STN
- TI Wall-hanging type magnetic displaying device
- L4 ANSWER 19 OF 50 USPATFULL on STN
- TI Surface treatment method
- L4 ANSWER 20 OF 50 USPATFULL on STN
- TI Coating method and article produced thereby
- L4 ANSWER 21 OF 50 USPATFULL on STN
- TI Cements
- L4 ANSWER 22 OF 50 USPATFULL on STN
- TI Filter for protection against radiation, especially with regard to direct pigmentation by solar radiation
- L4 ANSWER 23 OF 50 USPATFULL on STN
- TI Homogeneous, highly-filled, polyolefin composites
- L4 ANSWER 24 OF 50 USPATFULL on STN
- TI Primer composition and coating method using said composition
- L4 ANSWER 25 OF 50 USPATFULL on STN

L4

=> d L4 8 25 ti abs bib

ANSWER 8 OF 50 USPATFULL on STN

```
Glass composition for covering semiconductor element
ΤI
       A glass composition for covering a semiconductor element. The glass
AB
       composition has excellent resistance to chemicals and excellent electric
       characteristics. The glass composition includes 3 to 8% by weight of
       Al.sub.2 O.sub.3, 35 to 45% by weight of SiO.sub.2, 10 to 30% by weight
       of ZnO, 5 to 30% by weight of PbO, 1 to 10% by weight of B.sub.2
       O.sub.3, and more than 5% but not exceeding 20% by weight of an alkaline
       earth metal oxide selected from the group consisting of MgO, CaO, SrO
       and BaO, where the maximum contents of MgO, CaO, SrO and BaO are 7% by
       weight, 3% by weight, 7% by weight, and 15% by weight, respectively.
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
       85:55311 USPATFULL
       Glass composition for covering semiconductor element
ΤI
       Furukawa, Kazuyoshi, Kawasaki, Japan
IN
       Shimbo, Masaru, Yokohama, Japan
       Fukuda, Kiyoshi, Yokohama, Japan
       Tanzawa, Katsujirou, Yokohama, Japan
       Tokyo Shibaura Denki Kabushiki Kaisha, Kawasaki, Japan (non-U.S.
PΑ
       corporation)
       US 4542105
                               19850917
PΙ
       US 1982-454248
                               19821229 (6)
AΙ
       JP 1982-7930
                           19820121
PRAI
DT
       Utility
       Granted
      Primary Examiner: McCarthy, Helen M.
EXNAM
       Oblon, Fisher, Spivak, McClelland & Maier
LREP
       Number of Claims: 4
CLMN
       Exemplary Claim: 1
ECL
DRWN
       No Drawings
LN.CNT 520
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
     ANSWER 25 OF 50 USPATFULL on STN
L4
       Glass for the passivation of semiconductor devices
TI
       A passivating glass for semiconductor devices. The glass contains
AB
       GeO.sub.2, PbO, SiO.sub.2 and Al.sub.2 O.sub.3 and, in addition, a small
       defined quantity of water.
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
AN
       79:25749 USPATFULL
       Glass for the passivation of semiconductor devices
ΤI
       Trap, Hendrikus J. L., Eindhoven, Netherlands
IN
       U.S. Philips Corporation, New York, NY, United States (U.S. corporation)
PA
                               19790522
PΙ
       US 4156250
ΑI
       US 1977-793881
                               19770504 (5)
       NL 1976-4951
                           19760510
PRAI
DT
       Utility
       Granted
       Primary Examiner: Larkins, William D.
EXNAM
       Briody, Thomas A., Connors, Jr., Edward J., Cannon, Jr., James J.
LREP
CLMN
       Number of Claims: 6
       Exemplary Claim: 1
ECL
       1 Drawing Figure(s); 1 Drawing Page(s)
CAS INDEXING IS AVAILABLE FOR THIS PATENT.
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- L4 ANSWER 25 OF 50 USPATFULL on STN
- TI Glass for the passivation of semiconductor devices
- L4 ANSWER 26 OF 50 USPATFULL on STN
- TI Non-settling coating composition and flatting pigment
- L4 ANSWER 27 OF 50 USPATFULL on STN
- TI Displaying magnetic panel and its display device
- L4 ANSWER 28 OF 50 USPATFULL on STN
- TI Cements
- L4 ANSWER 29 OF 50 USPATFULL on STN
- TI Finely distributed polyvinyl chloride molding compositions capable of being sintered
- L4 ANSWER 30 OF 50 USPATFULL on STN
- TI Glass composition for passivating semiconductor surfaces
- L4 ANSWER 31 OF 50 USPATFULL on STN
- TI Highly filled polyurea foams
- L4 ANSWER 32 OF 50 USPATFULL on STN
- TI Inorganic-organic compositions
- L4 ANSWER 33 OF 50 USPATFULL on STN
- TI Filtering process using inorganic synthetically prepared filter sand
- L4 ANSWER 34 OF 50 USPATFULL on STN
- TI Low power high voltage thermopile
- L4 ANSWER 35 OF 50 USPATFULL on STN
- TI Method of making a fluorescent display device having segmentary anodes
- L4 ANSWER 36 OF 50 USPATFULL on STN
- TI Water glass composition
- L4 ANSWER 37 OF 50 USPATFULL on STN
- TI Cements comprising acrylic acid/itaconic acid copolymer and fluoroaluminosilicate glass powder
- L4 ANSWER 38 OF 50 USPATFULL on STN
- TI Construction material with calcium silicate monohydrate produced thereon in situ and composition therefor
- L4 ANSWER 39 OF 50 USPATFULL on STN
- TI Enamel glaze composition
- L4 ANSWER 40 OF 50 USPATFULL on STN
- TI Water permeability reducing inorganic coating slurry composition
- L4 ANSWER 41 OF 50 USPATFULL on STN
- TI LUBRICANT CONTAINING THE INORGANIC POLYMERIC GRAPHITE FLUORIDE IN AN IMPROVED DISPERSED STATE THEREOF AND METHOD FOR THE MANUFACTURE OF THE SAME
- L4 ANSWER 42 OF 50 USPATFULL on STN
- TI PASSIVATING METHOD
- L4 ANSWER 43 OF 50 USPATFULL on STN
- TI METHOD FOR MAKING MAGNETIC HEAD COMPOSED OF FERRITE
- L4 ANSWER 44 OF 50 USPATFULL on STN
- TI PASSIVATING SOLUTION AND METHOD

- L4 ANSWER 45 OF 50 USPATFULL on STN
- TI MANUFACTURE OF BOROSILICATE GLASS POWDER ESSENTIALLY FREE OF ALKALI AND ALKALINE EARTH METALS
- L4 ANSWER 46 OF 50 USPATFULL on STN
- TI ELASTOMERIC THERMOPLASTIC POLYESTER POLYURETHANE COMPOSITIONS STABILIZED AGAINST HYDROLYSIS
- L4 ANSWER 47 OF 50 USPATFULL on STN
- TI METHOD OF COATING SOLAR CELL WITH BOROSILICATE GLASS AND RESULTANT PRODUCT
- L4 ANSWER 48 OF 50 PCTFULL COPYRIGHT 2006 Univentio on STN
- TIEN EXPRESSION OF ENZYMATICALLY ACTIVE REVERSE TRANSCRIPTASE
- TIFR EXPRESSION D'UNE TRANSCRIPTASE INVERSE ENZYMATIQUEMENT ACTIVE
- L4 ANSWER 49 OF 50 PCTFULL COPYRIGHT 2006 Univentio on STN
- TIEN A METHOD OF DETECTING OR DETERMINING HISTAMINE IN HISTAMINE CONTAINING MATERIALS, PARTICULARLY BODY FLUIDS AND AN ANALYTICAL MEANS FOR USE IN SUCH METHOD
- TIFR PROCEDE DE DETECTION OU DE DETERMINATION DE L'HISTAMINE DANS DES MATERIAUX CONTENANT DE L'HISTAMINE, NOTAMMENT DES FLUIDES DU CORPS ET MOYENS ANALYTIQUES UTILISES DANS CE PROCEDE
- L4 ANSWER 50 OF 50 PCTFULL COPYRIGHT 2006 Univentio on STN
- TIEN SHAPED ARTICLE AND COMPOSITE MATERIAL AND METHOD FOR PRODUCING SAME
- TIFR ARTICLE FORME ET MATERIAU COMPOSITE ET LEUR PROCEDE DE PRODUCTION

=> d L4 45 ti abs bib

- L4 ANSWER 45 OF 50 USPATFULL on STN
- TI MANUFACTURE OF BOROSILICATE GLASS POWDER ESSENTIALLY FREE OF ALKALI AND ALKALINE EARTH METALS
- AB An intimate mixture of a boric oxide source compound and colloidally subdivided amorphous silica is slowly heated to evolve all moisture and boric oxide source decomposition products. The mixture is then heated to a final temperature between 500° and 900° C. to form a borosilicate glass powder directly, or to form a borosilicate glass agglomerate which may readily be crushed to a powder.
- AN 73:45348 USPATFULL
- TI MANUFACTURE OF BOROSILICATE GLASS POWDER ESSENTIALLY FREE OF ALKALI AND ALKALINE EARTH METALS
- IN Iler, Ralph K., Wilmington, DE, United States
- PA E. I. du Pont de Nemours and Company, Wilmington, DE, United States (U.S. corporation)
- PI US 3762936 19731002
- AI US 1971-112007 19710202 (5)
- RLI Continuation-in-part of Ser. No. US 1967-657042, filed on 31 Jul 1967, now abandoned
- DT Utility
- FS Granted
- EXNAM Primary Examiner: Curtis, A. B.; Assistant Examiner: Bell, Mark
- LREP Reinert; Norbert F.
- CLMN Number of Claims: 5
- DRWN No Drawings

FULL ESTIMATED COST

LN.CNT 364

=> FIL STNGUIDE

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